Vishay Siliconix

COMPLIANT

HALOGEN

**FREE** 

# **E Series Power MOSFET**

### Thin-Lead TO-220 FULLPAK



G	
N-Channel MOSFE	T

85	50
$V_{GS} = 10 \text{ V}$	1.17
16	5.5
3	3
6	6
Sin	gle
	85 V <sub>GS</sub> = 10 V 16 3 6 Sin

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA5N80AE-GE3

ABSOLUTE MAXIMUM RATINGS (T	<sub>C</sub> = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			$V_{DS}$	800	V
Gate-source voltage			$V_{GS}$	± 30	V
Continuous drain surrent /T 150 °C\ 6	\/ at 10 \/	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		3.0	
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	1.9	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	7	
Linear derating factor				0.5	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	17	mJ
Maximum power dissipation			$P_{D}$	29	W
Operating junction and storage temperature range	Э		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope $T_J = 125$		T <sub>J</sub> = 125 °C	dv/dt	70	V/ns
Reverse diode dv/dt <sup>d</sup>			αν/ατ	0.3	V/IIS
Soldering recommendations (peak temperature) c		For 10 s		260	°C
Mounting torque, M3 screw				0.6	Nm

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 1.1 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_{.l}$  = 25 °C
- e. Limited by maximum junction temperature



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THERMAL RESISTANCE RATI	NGS		
PARAMETER	SYMBOL	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	65	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	4.3	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							•
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
Coto por man lankaga	1	,	$V_{GS} = \pm 20 \text{ V}$	-	-	± 10	
Gate-source leakage	$I_{GSS}$	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 50	μA
Zoro goto voltago drain ourrent	1	V <sub>DS</sub> =	800 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.5 A	-	1.17	1.35	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 2 A	-	1.2	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,		321	-	
Output capacitance	C <sub>oss</sub>	Ţ,	$V_{DS} = 100 \text{ V},$	-	20	-	1
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz		4	-	pF
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	14	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0 V	/ to 480 V, V <sub>GS</sub> = 0 V	-	71	-	
Total gate charge	Qg			-	11	16.5	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 2 A, V_{DS} = 640 V$	-	3	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	6	-	
Turn-on delay time	t <sub>d(on)</sub>			-	12	24	
Rise time	t <sub>r</sub>	V <sub>DD</sub> :	= 640 V, I <sub>D</sub> = 2 A,	-	8	16	no
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$=$ 10 V, R <sub>g</sub> = 9.1 $\Omega$	-	10	20	ns
Fall time	t <sub>f</sub>			-	28	56	
Gate input resistance	$R_g$	f = 1 MHz, open drain		1.6	3.2	6.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the		-	-	4.4	
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction		-	-	7	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 2 A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	-		-	267	534	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 2 \text{A},$		-	1.2	2.4	μC
Reverse recovery current	I <sub>RRM</sub>		100 A/ $\mu$ s, V <sub>R</sub> = 25 V	_	7.5	-	A

#### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

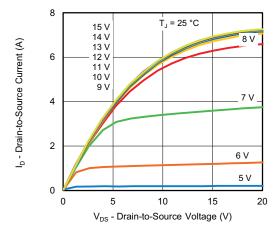


Fig. 1 - Typical Output Characteristics

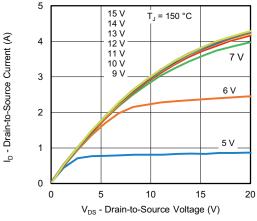


Fig. 2 - Typical Output Characteristics

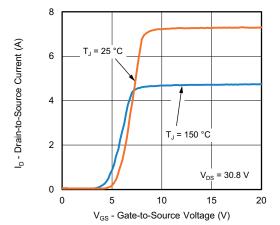


Fig. 3 - Typical Transfer Characteristics

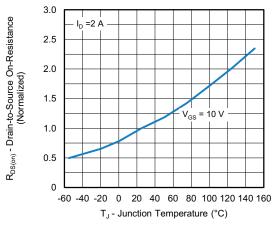


Fig. 4 - Normalized On-Resistance vs. Temperature

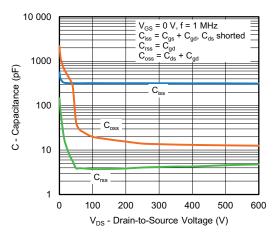


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

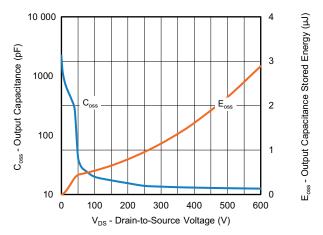


Fig. 6 - Coss and Eoss vs. VDS



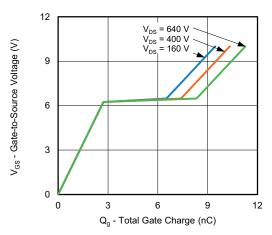


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

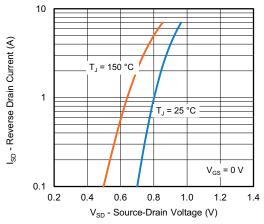


Fig. 8 - Typical Source-Drain Diode Forward Voltage

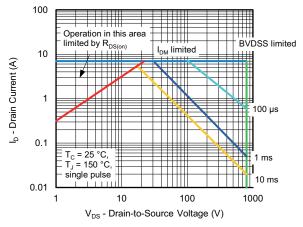


Fig. 9 - Maximum Safe Operating Area



a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

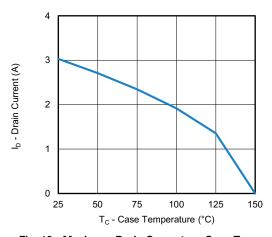


Fig. 10 - Maximum Drain Current vs. Case Temperature

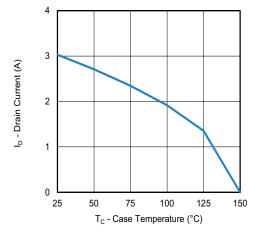


Fig. 11 - Normalized Breakdown Voltage vs. Temperature



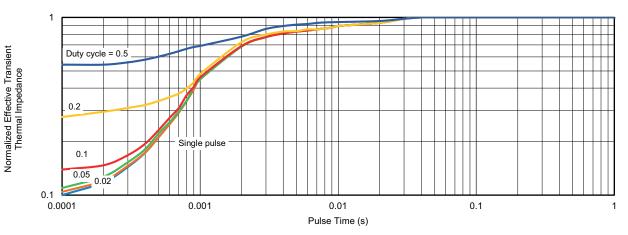


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

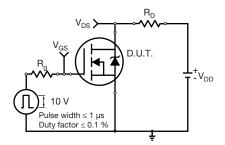


Fig. 13 - Switching Time Test Circuit

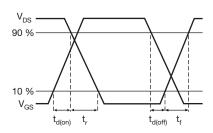


Fig. 14 - Switching Time Waveforms

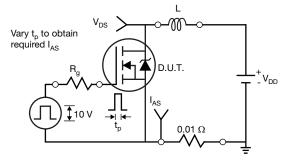


Fig. 15 - Unclamped Inductive Test Circuit

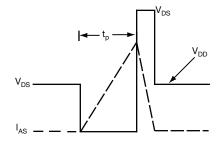


Fig. 16 - Unclamped Inductive Waveforms

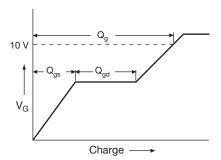


Fig. 17 - Basic Gate Charge Waveform

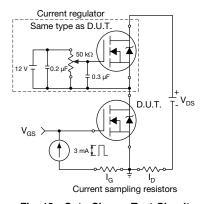


Fig. 18 - Gate Charge Test Circuit



#### Peak Diode Recovery dv/dt Test Circuit

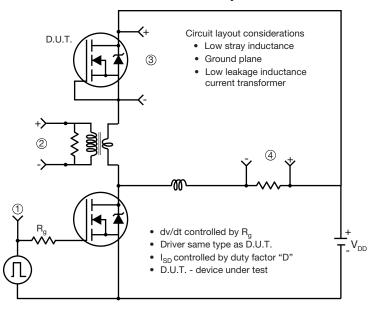


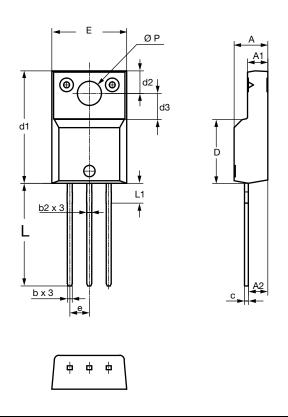


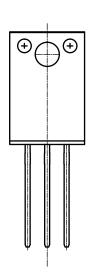
Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





SYMBOL	DIMENSIONS					
	MILLIN	IETERS	INCHES			
	MIN.	MAX.	MIN.	MAX.		
А	4.30	4.70	0.169	0.185		
A1	2.50	2.90	0.098	0.114		
A2	2.40	2.80	0.094	0.110		
b	0.60	0.80	0.024	0.031		
b2	0.60	0.90	0.024	0.035		
С	-	0.60	-	0.024		
D	8.30	8.70	0.327	0.342		
d1	14.70	15.30	0.579	0.602		
d2	2.90	3.10	0.114	0.122		
d3	3.30	3.70	0.130	0.146		
Е	9.70	10.30	0.382	0.406		
е	2.50	2.70	0.098	0.106		
L	13.40	13.80	0.528	0.543		
L1	1.00	2.80	0.039	0.110		
ØP	3.00	3.40	0.118	0.134		

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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